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N-Channel SuperFET[®] II MOSFET

800 V, 3.5 A, 2.25 Ω

FCPF2250N80Z

Features

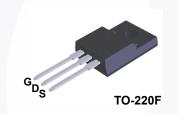
- R_{DS(on)} = 1.8 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 11 nC)
- Low E_{oss} (Typ. 1.1 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 51 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

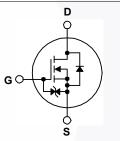
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

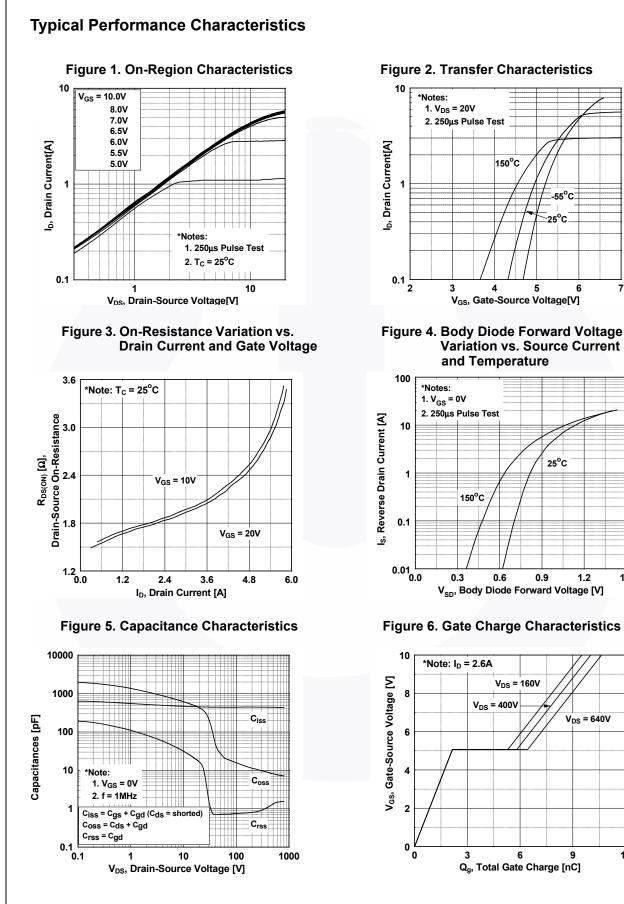
| Symbol | | FCPF2250N80Z | Unit | | | |
|-----------------------------------|--|--|--|-------------|------|--|
| V _{DSS} | Drain to Source Voltage | | 800 | V | | |
| V _{GSS} | Cata ta Sauraa Valtaga | - DC | - DC | | | |
| | Gate to Source Voltage | - AC | - AC (f > 1 Hz) | | | |
| ID | Drain Current | - Continuous (T _C = 25 ^o C) | 3.5* | Α | | |
| | Drain Current | - Continuous (T _C = 100 ^o C) | - Continuous (T _C = 100 ^o C) | | | |
| I _{DM} | Drain Current | - Pulsed | (Note 1) | 6.5* | Α | |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | | 21.6 | mJ | |
| I _{AR} | Avalanche Current (Note | | | 0.52 | Α | |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | | 0.22 | mJ | |
| dv/dt | MOSFET dv/dt | 100 | V/ns | | | |
| | Peak Diode Recovery dv/dt | 20 | | | | |
| P _D | Power Dissipation | (T _C = 25°C) | | 21.9 | W | |
| | Fower Dissipation | - Derate Above 25°C | | 0.18 | W/ºC | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | | -55 to +150 | °C | |
| TL | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | | | 300 | °C | |
| Drain current limited | d by maximum junction temperature, with h | eatsink. | | | · | |

Thermal Characteristics

| Symbol | Parameter | FCPF2250N80Z | Unit | |
|-----------------------|---|--------------|------|--|
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | 5.7 | °C/W | |
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient, Max. | 62.5 | 0/10 | |

August 2015

| | | FCPF2250N80Z | TO-2 | 220F | Tube | NI/A | | NI/A | | F0 |
|--|--|--------------------------|-----------------------|--|--|----------|-----|-------------------|----------------|----------|
| | | | | ckagePacking MethodReel S-220FTubeN/A | | | N// | | | 50 units |
| | Chara | | 5 ^o C unle | ess othe | erwise noted. | | | | | |
| Symbol | | Parameter | | | Test Conditions | | | Тур. | Max. | Unit |
| Off Charact | teristics | | | | | | | | | |
| BV _{DSS} | 1 | Source Breakdown Volta | ae | V _{CS} = | 0 V, I _D = 1 mA, T _J = : | 25°C | 800 | - | - | V |
| ABV _{DSS} | Breakdown Voltage Temperature | | • | | | | | 0.95 | | V/ºC |
| $/\Delta T_{J}$ | Coefficient | | | $I_D = 1 \text{ mA}$, Referenced to 25° C | | | - | 0.85 | - | V/°(|
| I _{DSS} | Zero Gate Voltage Drain Current | | | V _{DS} = 800 V, V _{GS} = 0 V | | | - | - | 25 | μA |
| USS | | | | V_{DS} = 640 V, V_{GS} = 0 V, T_C = 125°C | | | - | - | - 250 | μΛ |
| I _{GSS} | Gate to B | to Body Leakage Current | | | ±20 V, V _{DS} = 0 V | | - | - | ±10 | μA |
| On Charact | teristics | | | | | | | | | |
| V _{GS(th)} | Gate Thre | eshold Voltage | | V _{GS} = | V _{DS} , I _D = 0.26 mA | | 2.5 | - | 4.5 | V |
| R _{DS(on)} | Static Dra | ain to Source On Resista | ance | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.3 \text{ A}$ | | | - | 1.8 | 2.25 | Ω |
| 9 _{FS} | Forward ⁻ | Transconductance | | V _{DS} = 20 V, I _D = 1.3 A | | | - | 2.28 | - | S |
| Dynamic Cl C _{iss} C _{oss} C _{rss} | Input Cap Output Ca | | | V _{DS} = f = 1 N | 100 V, V _{GS} = 0 V, IHz | | - | 440 16 0.75 | 585 22 - | pF pF |
| C _{oss} | Output Ca | apacitance | | V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz | | | - | 8.4 | - | pF |
| C _{oss(eff.)} | Effective | ctive Output Capacitance | | $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$ | | | - | 51 | - | pF |
| Q _{g(tot)} | Total Gate | e Charge at 10V | | $V_{DS} = 640 \text{ V}, \text{ I}_{D} = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4) | | | - | 11 | 14 | nC |
| Q _{gs} | Gate to S | ource Gate Charge | | | | - | 2.2 | - | nC | |
| Q _{gd} | Gate to D | rain "Miller" Charge | | | | (Note 4) | - | 4.3 | - | nC |
| ESR | Equivaler | nt Series Resistance | | f = 1 N | IHz | | - | 2.8 | - | Ω |
| Switching (| Characte | eristics | | | | | | | | |
| t _{d(on)} | Turn-On I | Delay Time | | V_{DD} = 400 V, I _D = 2.6 A, V _{GS} = 10 V, R _g = 4.7 Ω | | | - | 11 | 32 | ns |
| t _r | Turn-On I | Rise Time | | | | - | 6.7 | 23 | ns | |
| t _{d(off)} | Turn-Off I | Delay Time | | | | - | 26 | 62 | ns | |
| t _f | Turn-Off I | Fall Time | | (Note 4) | | | | 8.7 | 27 | ns |
| Drain-Sour | ce Diod | e Characteristics | | | | | | | | |
| I _S | Maximum Continuous Drain to Source Diode Forward Current | | | | | - | - | 3.5 | А | |
| I _{SM} | Maximum Pulsed Drain to Source Diod | | | e Forward Current | | | - | - | 6.5 | Α |
| V _{SD} | Drain to S | Source Diode Forward V | /oltage | V _{GS} = 0 V, I _{SD} = 2.6 A | | | - | - | 1.2 | V |
| t _{rr} | Reverse I | Recovery Time | | V _{GS} = 0 V, I _{SD} = 2.6 A, | | - | 260 | - | ns | |
| | Reverse I | Recovery Charge | | dI _F /dt = 100 A/μs | | | - | 2.2 | - | μC |



-55°C 25°C

6

25°C

1.2

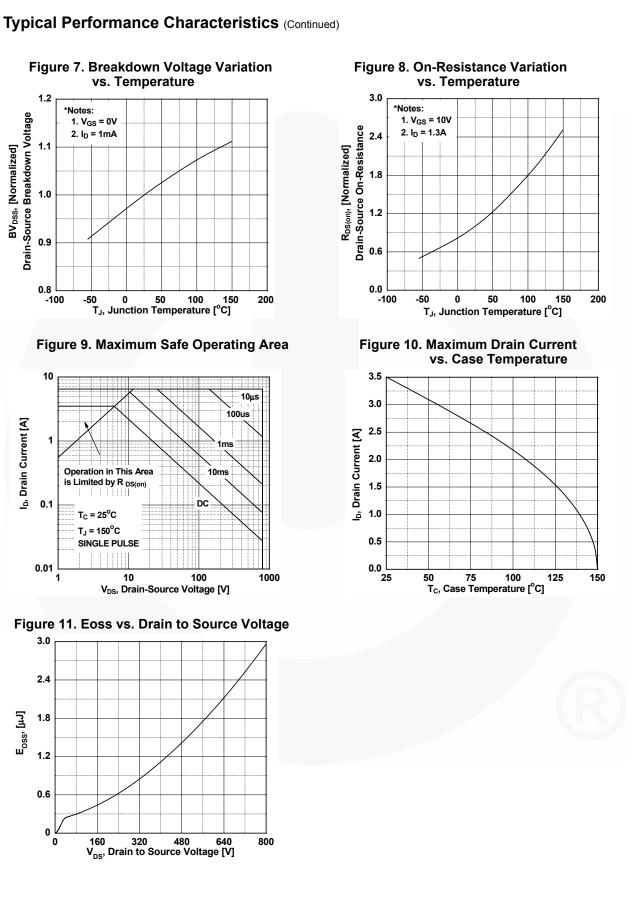
V_{DS} = 640V

9

1.5

7

12



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1.2

1.1

1.0

0.9

0.8

10

1

0.1

0.01

3.0

2.4

1.2

0.6

0

0

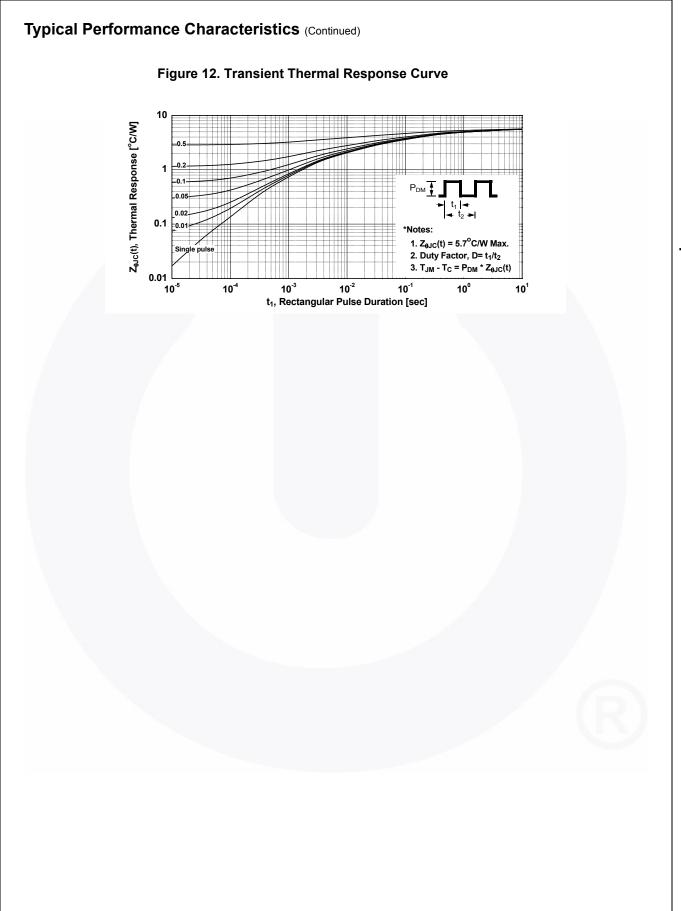
E_{oss}, [µJ] 1.8 1

I_b, Drain Current [A]

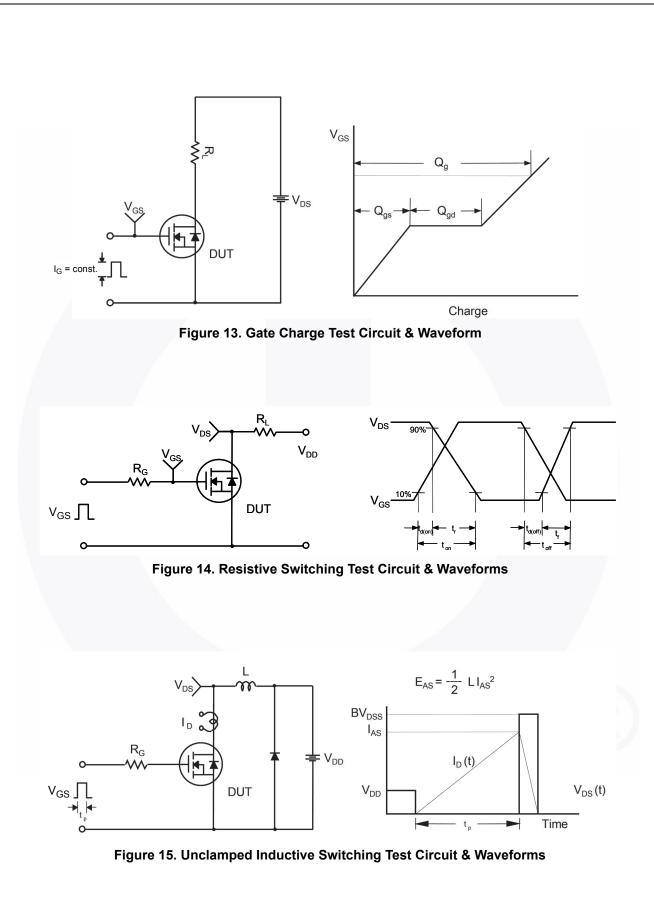
-100

Drain-Source Breakdown Voltage

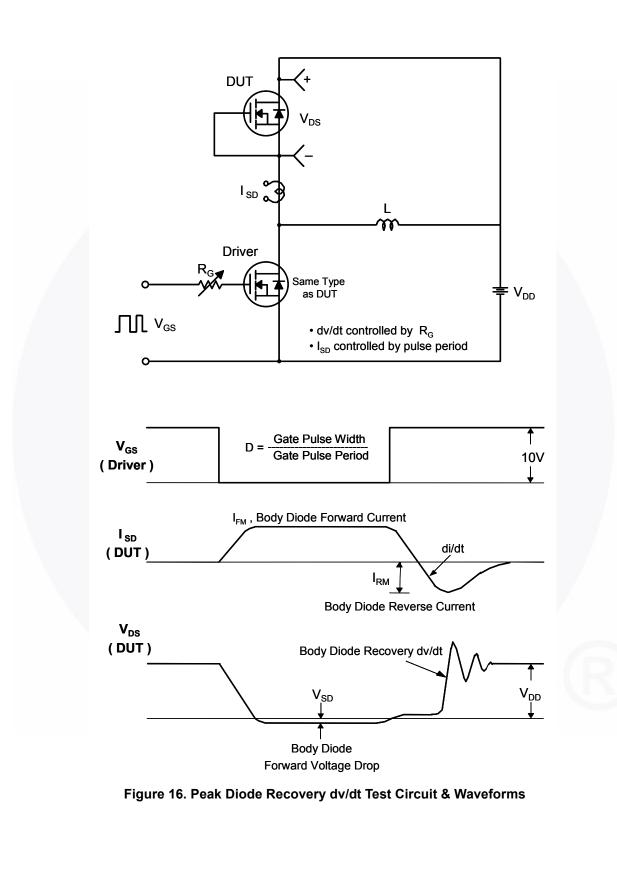
BV_{DSS}, [Normalized]

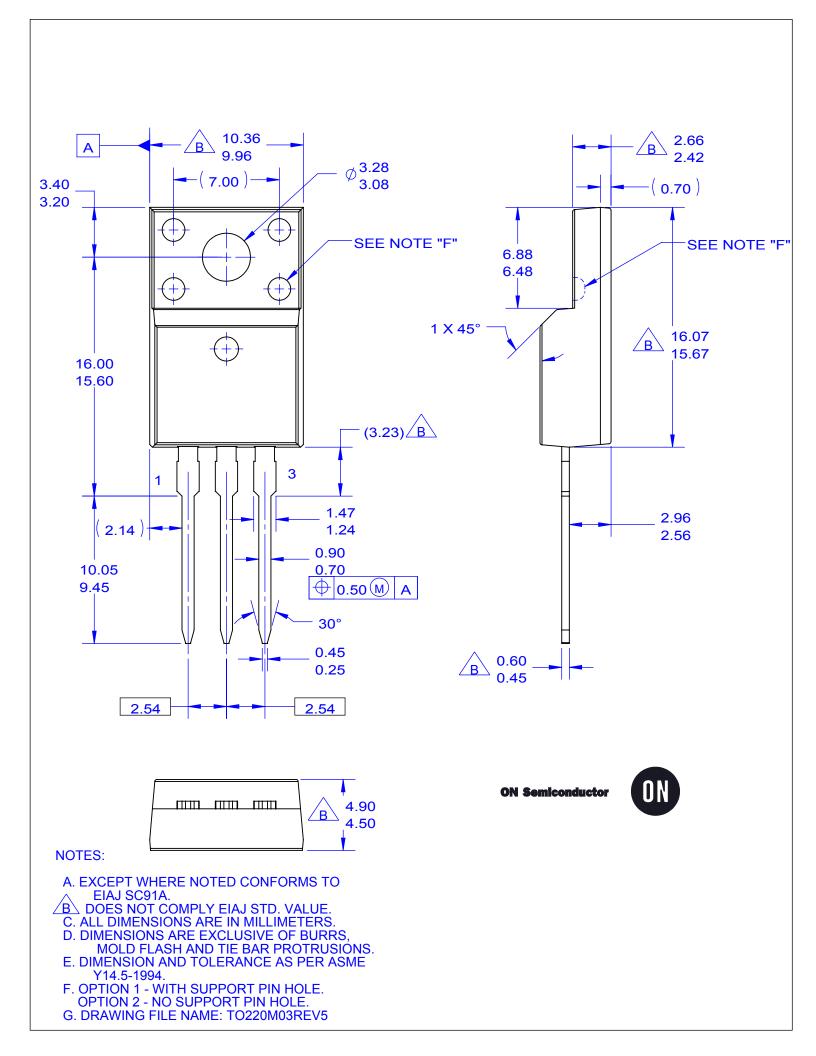


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FCPF2250N80Z — N-Channel SuperFET[®] II MOSFET





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